

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
LIYUN GAO	03/30/2022
XIAOFENG ZHANG	03/30/2022
CHADI MICHEAL DIBA	03/30/2022
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<b>City:</b>	ZHONGSHAN, GUANGDONG
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	528416
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17708908
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<b>NAME OF SUBMITTER:</b>	RICHARD M. MESCHER
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<b>DATE SIGNED:</b>	03/30/2022
<b>Total Attachments: 4</b>	
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## PATENT ASSIGNMENT

Whereas, we, **Liyun GAO**, having a mailing address of 4<sup>th</sup> Floor Wanhua Building, Wanhe Industrial Zone, No. 20 Dehe Road Jidongyi, Xiaolan Town, Zhongshan, Guangdong 528416 China, **Xiaofeng ZHANG**, having a mailing address of 4<sup>th</sup> Floor Wanhua Building, Wanhe Industrial Zone, No. 20 Dehe Road Jidongyi, Xiaolan Town, Zhongshan, Guangdong 528416 China, and **CHADI MICHEAL DIBA**, having a mailing address of 4<sup>th</sup> Floor Wanhua Building, Wanhe Industrial Zone, No. 20 Dehe Road Jidongyi, Xiaolan Town, Zhongshan, Guangdong 528416 China, have jointly invented certain new and useful improvements in inventions for an "ITCH RELIEVING DEVICE", for which we are contemporaneously filing a US patent application (Porter, Wright, Morris & Arthur Docket No. 4013023-23379);

And whereas, **Zhongshan TLC Electronics Co., Ltd.**, having a mailing address of 4<sup>th</sup> Floor Wanhua Building, Wanhe Industrial Zone, No. 20 Dehe Road Jidongyi, Xiaolan Town, Zhongshan, Guangdong 528416 China, is desirous of acquiring the entire right, title and interest in, to and under said inventions and said patent application, any continuing applications, continuations-in-part, divisional applications, refiled or reissue applications made in the United States of America which may result from said invention and information disclosed in said patent application, and any and all patents which may be issued therefrom;

Now, therefore, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, **Liyun GAO**, **Xiaofeng ZHANG**, and **CHADI MICHEAL DIBA**, do hereby sell, assign and transfer to **Zhongshan TLC Electronics Co., Ltd.**, the entire right, title and interest, in and to my inventions of a "ITCH RELIEVING DEVICE", said patent application, the inventions therein described, and all rights appurtenant thereto and in all our applications related thereto, including each of the following: the right to apply for any utility or design patents for said inventions in the United States of America, any and all other applications for patents on said inventions including all non-provisional, divisional, and continuation applications based in whole or in part upon said inventions or upon said applications or related thereto; any and all patents that may issue thereon in the United States of America and any and all reissues, divisions, or continuations of patents granted for said inventions or upon said applications, to the full end of the term or terms for which said patent may be issued; and every priority or other right accorded by every international convention, treaty or agreement that is or may be predicated upon or arise from said inventions, application and other applications or patent therefor, all to be held and enjoyed by **Zhongshan TLC Electronics Co., Ltd.**, and its successors and assigns, all the same as we would have held and enjoyed had this Assignment not been made.

We hereby authorize and grant the right to **Zhongshan TLC Electronics Co., Ltd.**, and its successors and assigns, to file and prosecute patent applications in the United States of America on all or any part of said inventions in our names or in the name of **Zhongshan TLC Electronics Co., Ltd.**, and its successors and assigns, or otherwise, as **Zhongshan**

TLC Electronics Co., Ltd., and its successors and assigns, may deem advisable under any international convention, treaty, or agreement or otherwise.

We hereby request and authorize the Commissioner of Patents and Trademarks of the United States to grant, issue and transfer any patent for said invention to **Zhongshan TLC Electronics Co., Ltd.** as assignee of the entire right, title and interests therein, in accordance with this instrument of assignment.

Inventor:

**Liyun GAO**

Inventor Address:

4<sup>th</sup> Floor Wanhua Building, Wanhe Industrial Zone,  
No. 20 Dehe Road Jidongyi, Xiaolan Town, Zhongshan,  
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Inventor's Signature:

Liyun Gao

Date Signed:

2022. 03. 30.

Inventor:

Xiaofeng ZHANG

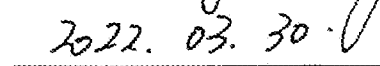
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\_\_\_\_\_

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Inventor:

**CHADI MICHEAL DIBA**

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CHADI MICHEAL DIBA.

Date Signed:

2022. 03. 30.

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